

Approval Specification	Customer's Approval Certificate
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Part No.:	Date:
Customer's Part No.:	Please return this copy as a certification of your approval

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Part No.	:	R915
Pages	:	7
Date	:	2015/9/29
Revision	:	1.0

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(Pb)

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## **R915**

915.0MHz

## **History Record**

Date	Part No.	Version No.	Modify Content	Remark

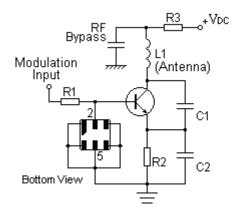
#### **R915**

#### Features

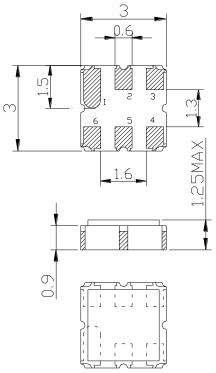
- 1-port Resonator
- Ceramic Package for Surface Mounted Technology (SMT)
- RoHS compatible
- Package size 3.0x3.0x1.25mm<sup>3</sup>
- Package Code DCC6C
- Electrostatic Sensitive Device(ESD)

## Application

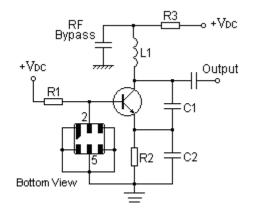
Typical Low-Power Transmitter Application



## Package Dimensions (DCC6C)



Typical Local Oscillator Application



## **Pin Configuration**

2	Input/Output		
5	Input/Output		
1,3,4,6	Case Ground		



#### **R915**

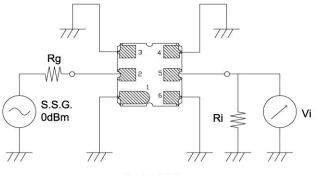
## 915.0MHz

## Marking



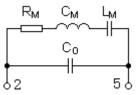
•	Pin 1
R	SAW Resonator
915	Part number

## **Test Circuit**



Rg=Ri=50Ω

## Equivalent LC Model



## Performance

#### **Maximum Rating**

Item		Value	Unit
DC Voltage	VDC	±30	V
Operation Temperature	т	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	°C
RF Power Dissipation	Р	15	dBm

#### **R915**

#### 915.0MHz

#### **Electronic Characteristics**

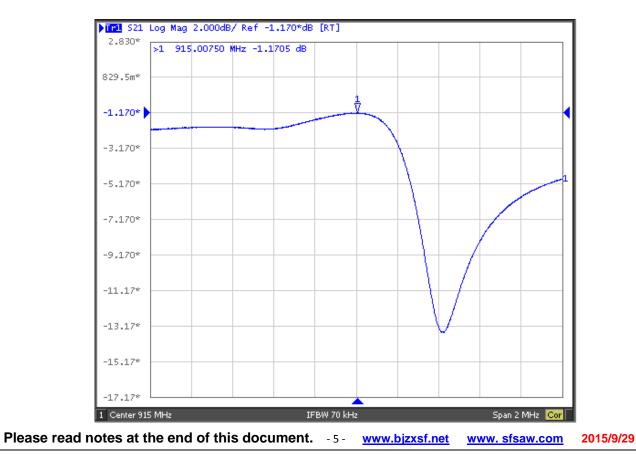
Test Temperature: 25°C±2°C

Terminating source impedance: 50Ω

Terminating load impedance: 50Ω

	Item			Typical	Maximum	Unit
Center	Absolute Frequency	fc		915.00		MHz
Frequency	Tolerance from 915.00MHz	∆fc		±150		KHz
Insertion Loss(n	nin)	IL		1.2	2.0	dB
Quality Easter	Unloaded Q	Qu		15069		
Quality Factor	50Ω Loaded Q	QL		715		
Frequency Aging	Absolute Value during the First Year	f <sub>A</sub>		≤10		ppm/yr
DC Insulation R	DC Insulation Resistance between Any Two Pins		1.0			MΩ
	Motional Resistance	Rм		4.9	10.0	Ω
RF Equivalent	Motional Inductance	L <sub>M</sub>		13.0		μH
RLC Model	Motional Capacitance	См		2.54		fF
	Static Capacitance	C <sub>0</sub>	2.55	2.85	3.15	pF

## **Frequency Response**

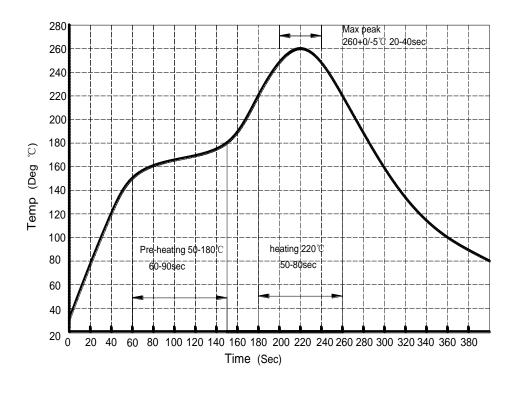


## **R915**

915.0MHz

Relia	bility (The SAW o	components shall remain electrical performance after tests)		
No.	Test item	Test condition		
1	Temperature Storage	<ul> <li>(1) Temperature: 85°C±2°C , Duration: 250h , Recovery time: 2h±0.5h</li> <li>(2) Temperature: -40°C±3°C , Duration: 250h ,Recovery time: 2h±0.5h</li> </ul>		
2	Humidity Test	Conditions: 60°C±2°C , 90~95% RH Duration: 250h		
3	Thermal Shock	Heat cycle conditions: TA=-40°C±3°C, TB=85°C±2°C, t1=t2=30min, Switch time: ≤3min , Cycle time: 100 times , Recovery time : 2h±0.5h.		
4	Vibration Fatigue	Frequency of vibration: 10~55HzAmplitude:1.5mmDirections: X,Y and ZDuration: 2h		
5	Drop Test	Cycle time: 10 times Height: 1.0m		
6	Solder Ability Test	Temperature: 245°C±5°CDuration: 3.0s5.0sDepth: DIP2/3 , SMD1/5		
7	Resistance to Soldering Heat	<ul> <li>(1)Thickness of PCB:1mm , Solder condition: 260°C±5°C , Duration: 10±1s</li> <li>(2)Temperature of Soldering Iron: 350°C±10°C , Duration: 3~4s , Recovery time : 2 ± 0.5h</li> </ul>		

## **Recommended Reflow Soldering Diagram**



**R915** 

## **SAW Resonator**

## Notes

- 1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to **ESD protect** in the test.
- 2. **Static voltage** between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
- 3. **Ultrasonic cleaning** may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- 4. Only leads of component may be soldered. Please avoid soldering another part of component.
- 5. There is a close relationship between the device's performance and **matching network**. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.